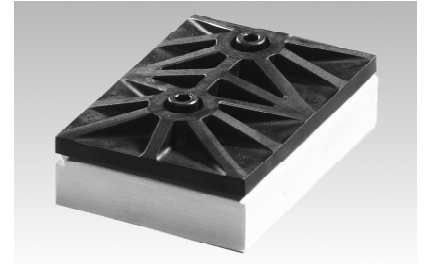


### SKiiP 30 NAB 12

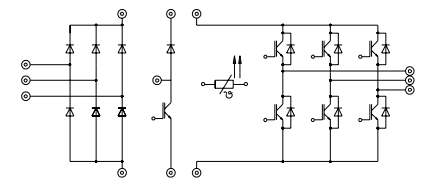
Absolute Maximum Ratings		
Symbol	Conditions <sup>1)</sup>	Units
Inverter	(Chopper see SKiiP 22 NAB 12)	
V <sub>CES</sub>		1200 V
V <sub>GES</sub>		± 20 V
I <sub>C</sub>	T <sub>heatsink</sub> = 25 / 80 °C	33 / 22 A
I <sub>CM</sub>	t <sub>p</sub> < 1 ms; T <sub>heatsink</sub> = 25 / 80 °C	66 / 44 A
I <sub>F</sub> = -I <sub>C</sub>	T <sub>heatsink</sub> = 25 / 80 °C	38 / 26 A
I <sub>FM</sub> = -I <sub>CM</sub>	t <sub>p</sub> < 1 ms; T <sub>heatsink</sub> = 25 / 80 °C	76 / 52 A
Bridge Rectifier		
V <sub>RRM</sub>		1500 V
I <sub>D</sub>	T <sub>heatsink</sub> = 80 °C	35 A
I <sub>FSM</sub>	t <sub>p</sub> = 10 ms; sin. 180°, T <sub>j</sub> = 25 °C	700 A
I <sup>2</sup> t	t <sub>p</sub> = 10 ms; sin. 180°, T <sub>j</sub> = 25 °C	2400 A <sup>2</sup> s
T <sub>j</sub>		- 40 ... + 150 °C
T <sub>stg</sub>		- 40 ... + 125 °C
V <sub>isol</sub>	AC, 1 min.	2500 V

### MiniSKiiP 3 SEMİKRON integrated intelligent Power SKiiP 30 NAB 12 3-phase bridge rectifier + braking chopper + 3-phase bridge inverter

Case M3



Characteristics			min.	typ.	max.	Units	
Symbol	Conditions <sup>1)</sup>						
IGBT - Inverter							
V <sub>CEsat</sub>	I <sub>C</sub> = 25 A T <sub>j</sub> = 25 (125) °C V <sub>CC</sub> = 600 V; V <sub>GE</sub> = ± 15 V I <sub>C</sub> = 25 A; T <sub>j</sub> = 125 °C R <sub>gon</sub> = R <sub>goff</sub> = 47 Ω inductive load		-	2,5(3,1)	3,0(3,7)	V	
t <sub>d(on)</sub>			-	75	150	ns	
t <sub>r</sub>			-	65	130	ns	
t <sub>d(off)</sub>			-	400	600	ns	
t <sub>f</sub>			-	50	100	ns	
E <sub>on</sub> + E <sub>off</sub>		-	6,2	-	-	mJ	
C <sub>ies</sub>	V <sub>CE</sub> = 25 V; V <sub>GE</sub> = 0 V, 1 MHz	-	1,65	-	-	nF	
R <sub>thjh</sub>	per IGBT	-	-	1,0	-	K/W	
IGBT - Chopper *							
V <sub>CEsat</sub>	I <sub>C</sub> = 15 A T <sub>j</sub> = 25 (125) °C V <sub>CC</sub> = 600 V; V <sub>GE</sub> = ± 15 V I <sub>C</sub> = 15 A; T <sub>j</sub> = 125 °C R <sub>gon</sub> = R <sub>goff</sub> = 82 Ω inductive load		-	2,5(3,1)	3,0(3,7)	V	
t <sub>d(on)</sub>			-	55	110	ns	
t <sub>r</sub>			-	45	90	ns	
t <sub>d(off)</sub>			-	400	600	ns	
t <sub>f</sub>			-	70	100	ns	
E <sub>on</sub> + E <sub>off</sub>		-	4,0	-	-	mJ	
C <sub>ies</sub>	V <sub>CE</sub> = 25 V; V <sub>GE</sub> = 0 V, 1 MHz	-	1,0	-	-	nF	
R <sub>thjh</sub>	per IGBT	-	-	1,4	-	K/W	
Diode <sup>2)</sup> - Inverter (Diode <sup>2)</sup> - Chopper see SKiiP 22 NAB 12)							
V <sub>F</sub> = V <sub>EC</sub>	I <sub>F</sub> = 25 A T <sub>j</sub> = 25 (125) °C T <sub>j</sub> = 125 °C T <sub>j</sub> = 125 °C I <sub>F</sub> = 25 A, V <sub>R</sub> = - 600 V di <sub>F</sub> /dt = - 500 A/μs V <sub>GE</sub> = 0 V, T <sub>j</sub> = 125 °C		-	2,0(1,8)	2,5(2,3)	V	
V <sub>TO</sub>			-	1,0	1,2	V	
r <sub>T</sub>			-	32	44	mΩ	
I <sub>RRM</sub>			-	25	-	A	
Q <sub>rr</sub>			-	4,5	-	μC	
E <sub>off</sub>			-	1,0	-	mJ	
R <sub>thjh</sub>		per diode	-	-	1,2	-	K/W
Diode - Rectifier							
V <sub>F</sub>	I <sub>F</sub> = 35 A, T <sub>j</sub> = 25 °C		-	1,2	-	V	
R <sub>thjh</sub>		per diode	-	-	1,6	-	K/W
Temperature Sensor							
R <sub>TS</sub>	T = 25 / 100 °C			1000 / 1670		Ω	
Mechanical Data							
M <sub>1</sub>	case to heatsink, SI Units		2	-	2,5	Nm	
Case	mechanical outline see page B 16 - 9			M3			



UL recognized file no. E63532

- specification of temperature sensor see part A
- common characteristics B 16 - 4

#### Options

- also available with powerful chopper. For characteristics please refer to Inverter IGBT

- 1) T<sub>heatsink</sub> = 25 °C, unless otherwise specified  
 2) CAL = Controlled Axial Lifetime Technology (soft and fast recovery)

\* For diagrams of the Chopper IGBT please refer to SKiiP 22 NAB 12

### MiniSKiiP 3

SKiiP 30 NAB 06  
 SKiiP 31 NAB 06  
 SKiiP 32 NAB 06  
 SKiiP 30 NAB 12  
 SKiiP 31 NAB 12  
 SKiiP 32 NAB 12

Circuit  
 Case M3  
 Layout and connections for the  
 customer's printed circuit board

